

AK8772

Shipped in packet-tape reel(5000pcs/Reel)

AK8772 is ultra-small Hall effect IC of a single silicon chip composed of Hall element and a signal processing IC.

Bipolar Hall Effect Latch

Supply Voltage 1.6~5.5V

Power down Function

Ultra High Sensitivity Bop:1.8mT

Output CMOS

SON

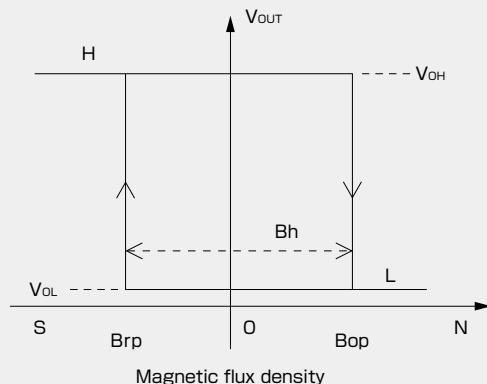
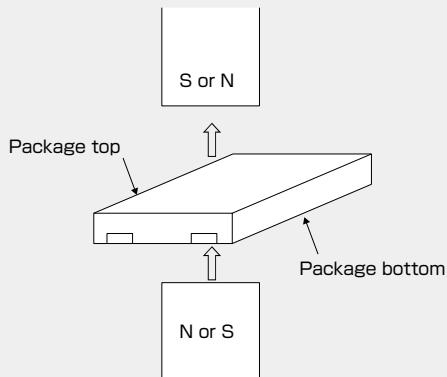
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●Features

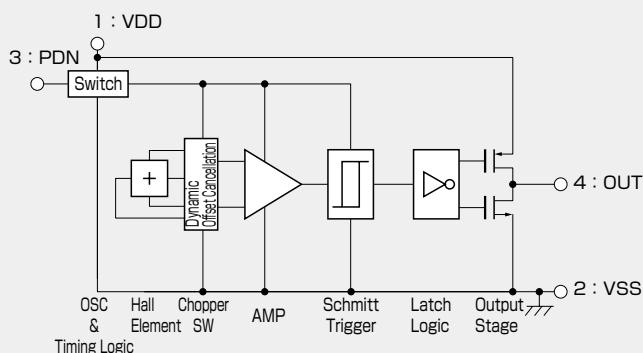
- Precision Bipolar Hall Effect Latch
- Power manageability through "PDN" pin
Current consumption in Power down mode is less than $1\ \mu\text{A}$
- Low current consumption at active mode : less than avg.
 $150\ \mu\text{A}@V_{DD}=3\text{V}$
- Ultra small SON package : $1.1 \times 1.4 \times 0.37\text{mm}$, Halogen free



●Operational Characteristics



●Functional Block Diagram



Item	Function
OSC	Generates operating clock
Timing Logic	Generates timing signal required for Chopper SW, AMP and other circuits
Hall Element	Hall element fabricated by CMOS process
Chopper SW	Performs chopping in order to cancel the offset voltage of Hall sensor
AMP	Reduces offset voltage and amplifies Hall output voltage
Schmitt Trigger	Hysteresis comparator
Latch Logic Output Stage	CMOS output. During the power down mode, output is latched in its previous state

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●Absolute Maximum Ratings

Item	symbol	Min.	Max.	Unit	Note
Power supply voltage	V_{DD}	-0.3	+6.5	V	
Output current	I_{OUT}	-0.5	+0.5	mA	OUT
Input voltage	V_{IN}	-0.3	$V_{DD}+0.3^*$	V	PDN
Input current	I_{IN}	-10	+10	mA	PDN
Storage temperature	T_{STG}	-55	+125	°C	

*) Less than +6.5V.

Note) Stress beyond these listed values may cause permanent damage to the device.

●Recommended Operating Conditions

Item	symbol	Min.	Typ.	Max.	Unit
Power supply voltage	V_{DD}	1.6	3.0	5.5	V
Operating temperature	T_a	-30		+85	°C

●Electrical Characteristics (Ta=25°C $V_{DD}=3.0V$)

Item	symbol	Min.	Typ.	Max.	Unit	Note
Current consumption 1	I_{DD1}			1	μA	PDN=0V
Current consumption 2	I_{DD2}		60	150	μA	PDN= V_{DD} ,Average
PDN input current	I_{IN}	-1		1	μA	
PDN input H voltage	V_{IH}	0.7 V_{DD}			V	
PDN input L voltage	V_{IL}			0.3	V	
High level output voltage	V_{OH}	$V_{DD}-0.4$			V	$I_{OUT}=-0.5mA$
Low level output voltage	V_{OL}			0.4	V	$I_{OUT}=+0.5mA$
PDN mode transition time 1	T_{PD1}			(36.6)	μs	*Active→PDN
PDN mode transition time 2	T_{PD2}			100	μs	PDN→Active
Pulse drive period	T_{PD3}	0.5	1.0	1.5	ms	When PDN= V_{DD}
Pulse drive time	T_{PD4}	12.2	24.4	36.6	μs	
PDN 'H' input pulse width	T_w	100			μs	

*) This transition time is not guaranteed by inspection because PDN input timing and internal timing are asynchronous

●Magnetic Characteristics① (Ta=25°C $V_{DD}=3.0V$)

Item	symbol	Min.	Typ.	Max.	Unit
Operating point	B_{op}		1.8	4.0	mT
Releasing point	B_{rp}	-4.0	-1.8		mT
Hysteresis	B_h		3.6		mT

●Magnetic Characteristics② (Ta=-30~+85°C $V_{DD}=1.6~5.5V$)

Item	symbol	Min.	Typ.	Max.	Unit
Operating point	B_{op}		1.8	4.2	mT
Releasing point	B_{rp}	-4.2	-1.8		mT
Hysteresis	B_h		3.6		mT

Note) The specifications in Magnetic Characteristics ② are design targets.

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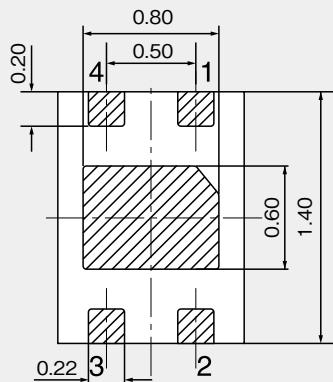
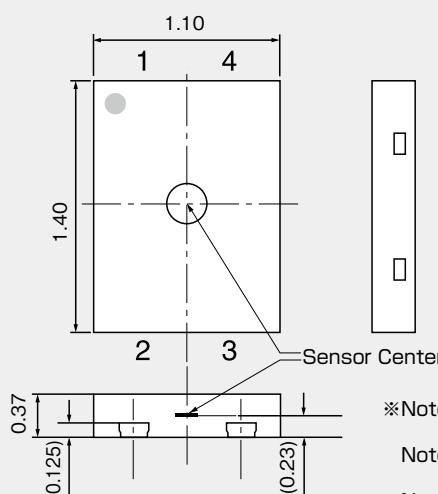
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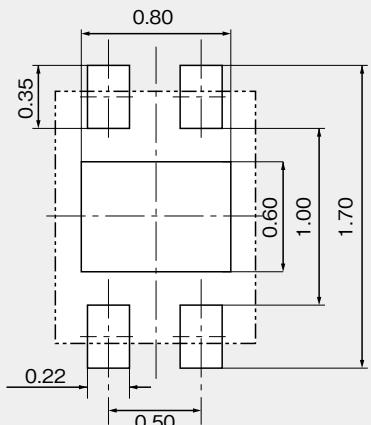
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●Package (Unit:mm)



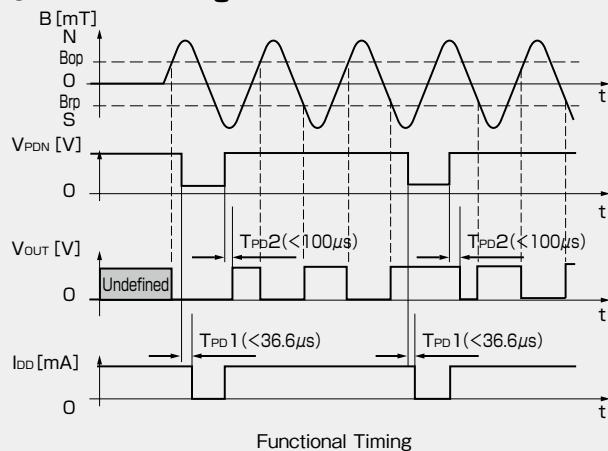
●Footprint (for reference)



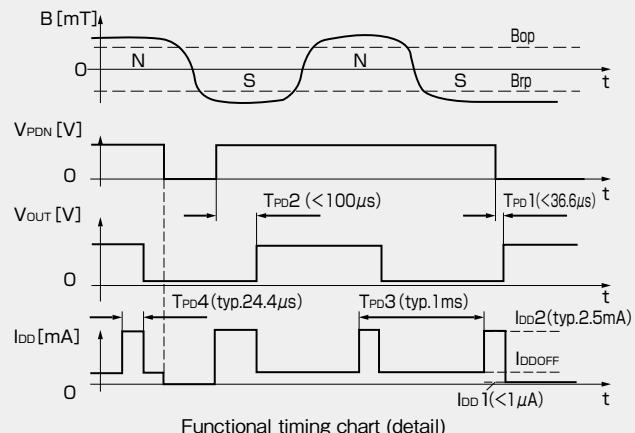
※Note 1) Sensitive area position referenced to the center of package within $\phi 0.3$ mm circle.
 Note 2) Tolerances of dimension otherwise noted is ± 0.05 mm.
 Note 3) Hatched area is plated.
 Note 4) Center pad area (TAB) should be tied to the VSS or floating

No.	Pin name	Function	Note
1	VDD	Power supply	
2	VSS	Ground	
3	PDN	Power down H:Device active L:Device power down	CMOS Input. This pin has to be tied to "H" level when external power control is not used.
4	OUT	Output	CMOS Output

●Function Timing Chart

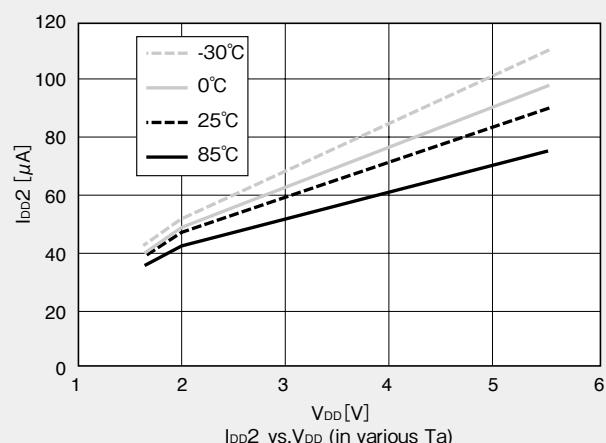
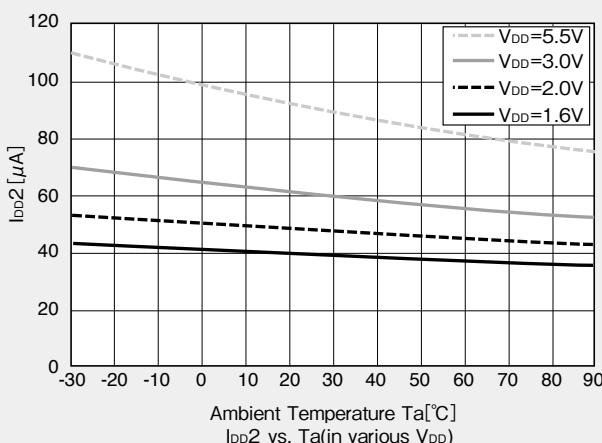
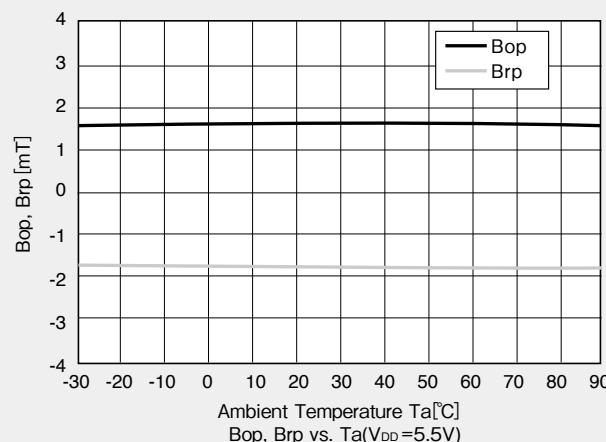
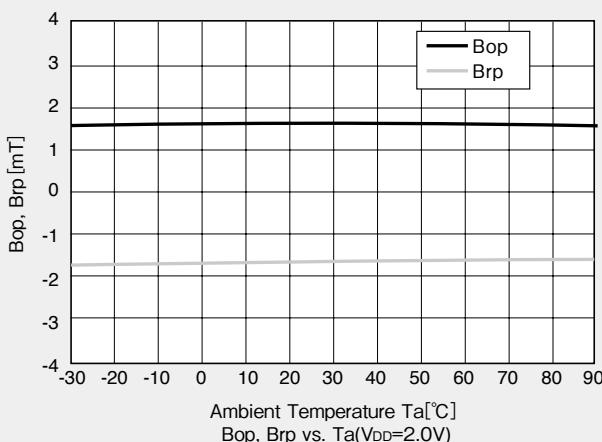
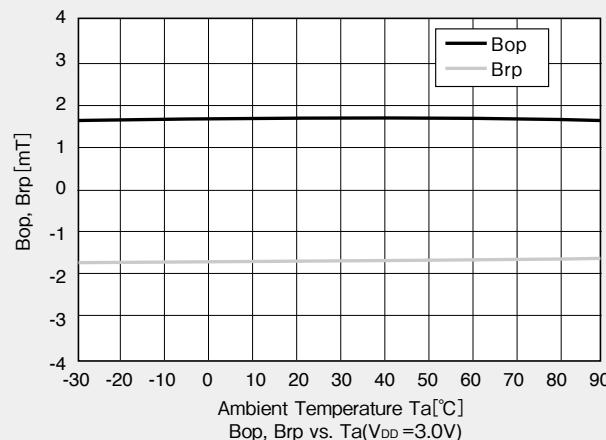
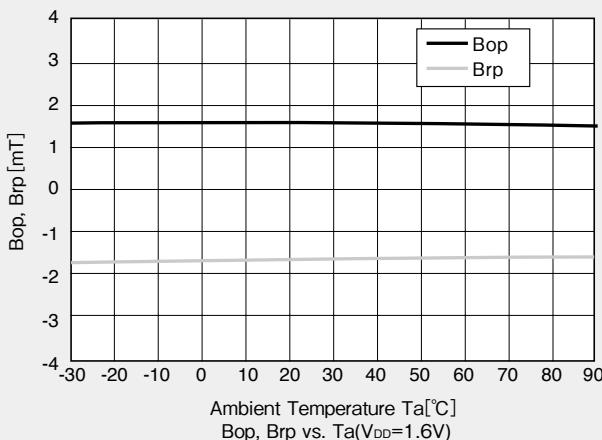


Note1) During power down mode, output is latched in its previous state.
 Note2) When VDD is supplied, the time from reaching $V_{DD} = 1.6V$ to the update of the output state is equal to T_{PD2} .

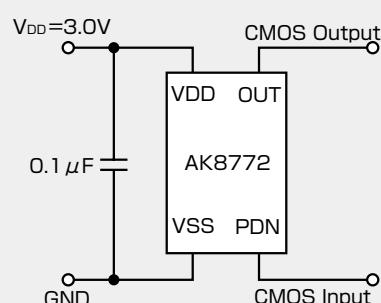


When PDN pin set to 'L' from 'H' during sampling is performing, the device transits to power down mode after sampling is completed. And when PDN pin set to 'L' from 'H' while sampling is not performing, the device transits to power down mode immediately.

● Typical Characteristic Data (for reference)



● Application Circuit



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